**Overview** 

### HP Elite x360 1040 14 inch G9 2-in-1 Notebook PC



#### Left

- 1. Internal Microphones (2)
- 2. Ambient Light Sensor (Optional)
- 3. Webcam
- 4. Camera Shutter
- 5 IR Camera (Optional)
- 6. IR Camera LEDs (Optional)
- 7. Glass Clickpad
- 1. SuperSpeed USB 20Gbps is not available with Thunderbolt<sup>TM</sup> 4.

- 8. Smartcard Reader (Optional)
- 9. LED Indicator
- **10.** Thunderbolt<sup>TM</sup> 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort<sup>TM</sup> 1.4)<sup>1</sup>
- **11.** Thunderbolt<sup>TM</sup> 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort<sup>TM</sup> 1.4)<sup>1</sup>
- **12.** SuperSpeed USB Type-A 5Gbps signaling rate (USB 3.2 Gen 1)
- 13. HDMI 2.0b Port (Cable not included)

### Overview



#### Right

- 1. Power Button Key
- 2. Audio Combo Jack
- **3.** SuperSpeed USB Type-A 5Gbps signaling rate (Charging)**6.** (USB 3.2 Gen 1)
- 4. Nano Security Lock Slot (Lock sold separately)
- 5. SIM Card Slot (Optional)

Touch Fingerprint Sensor (Select models)

Overview

### At a Glance

- Preinstalled with Windows 11 versions or FreeDOS
- A new x360 ultraslim design with precision-crafted magnesium chassis for a premium look and feel
- 12th Generation Intel® Core™ i5, i7 U series, up to ten-core
- New 16:10 ratio screen reduces the need to scroll by showing more vertical content than 16:9
- New 5MP camera with HP Auto Frame allows you around a little without losing viewers' attention during video calls
- New DDR5 memory (up to 16GB) and PCI Gen4 SSDs provide fast access to your work.
- Choice of displays:

35.6 cm (14"?) diagonal BV WUXGA (1920x1200) LED-backlit, 250 nits, 45% NTSC, touchscreen

35.6 cm (14"?) diagonal AG WUXGA (1920x1200) LED-backlit, 400 nits, 100% sRGB, touchscreen with HP Eye Ease

35.6 cm (14"?) diagonal BV WUXGA (1920x1200) LED-backlit, 400 nits, 100% sRGB, touchscreen with HP Eye Ease

35.6 cm (14"?) diagonal AG WUXGA (1920x1200) LED-backlit, 1000 nits, 100% sRGB, HP Sure View Reflect, touchscreen with HP Eye Ease

35.6 cm (14") diagonal BV WUXGA (1920x1200) LED-backlit, 1000 nits, 100% sRGB, HP Sure View Reflect, touchscreen with HP Eye Ease

- An optional HP Rechargeable Active Pen 3 with Magnetic Attach and 4096 Levels of pressure
- Choose from 38Wh or 51Wh battery options
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense.
- Larger Clickpad surface for easier, more intuitive input
- Connectivity with optional Intel® 5000 5G/WWAN available world-wide, and Thunderbolt<sup>™</sup> Docking (Dock sold separately)
- Undergoes MIL-STD 810H tests
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support all HP docking options including the HP Universal Dock G5

NOTE: See important legal disclosures for all listed specs in their respective features sections.



## PRODUCT NAME

HP Elite x360 1040 14 inch G9 2-in-1 Notebook PC

## **OPERATING SYSTEMS**

**Preinstalled** Windows 11 Pro <sup>1</sup>

Windows 11 Pro Education 1

Windows 11 Home - HP recommends Windows 11 Pro for business<sup>1</sup>

Windows 11 Home Single Language - HP recommends Windows 11 Pro for business<sup>1</sup> Windows 11 Pro (Windows 11 Enterprise available with a Volume Licensing Agreement) <sup>1</sup>

Windows 10 Pro (available through downgrade rights from Windows 11 Pro) 1,2

FreeDOS

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchase hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated are enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions v require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

## **PROCESSORS**

Processor	Cores Number of P-cores	er Number of	Threads	L3 Cache	Max Turbo Frequency		Base Frequency		Intel SIPP/vPro®	
3,4,5,6,7			E-cores	Timedus	Lacine	P- cores	E- cores	P- cores	E- cores	Enterprise
Intel® Core <sup>TM</sup> i7-	10	2	8	12	12MB	4.8	3.6	1.8	1.3	Х
1265U						GHz	GHz	GHz	GHz	
Intel® Core <sup>TM</sup> i7-	10	2	8	12	12MB	4.7	3.5	1.7	1.2	
1255U						GHz	GHz	GHz	GHz	
Intel® Core <sup>TM</sup> i5-	10	2	8	12	12MB	4.4	3.3	1.2	1.2	Х
1245U						GHz	GHz	GHz	GHz	
Intel® Core <sup>TM</sup> i5-	10	2	8	12	12MB	4.4	3.3	1.3	0.9	
1235U						GHz	GHz	GHz	GHz	

<sup>3.</sup> Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

<sup>4.</sup> Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode. 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.

<sup>6.</sup> In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

<sup>7.</sup> Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wirec LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of

### **Technical Specifications**

vPro® Essentials and Enterprise vary. See http://intel.com/vpro

## **CHIPSET**

Chipset is integrated with processor

### **GRAPHICS**

#### Integrated

Intel® Iris® X? Graphics 8

#### **Supports**

Support HD decode, DX12, HDMI 2.0b, HDCP 2.3 9

8. Intel® Iris® X? Graphics capabilities require system to be configured with Intel® Core<sup>TM</sup> i5 or i7 processors and dual channel memory. Intel® Iris® X? Graphics with Intel® Core<sup>TM</sup> i5 or 7 processors and single channel memory will only function as UHD graphics.

9. HDMI cable sold separately

## **DISPLAY**

#### Touch

35.56 cm (14") diagonal WUXGA Bent touch screen, BrightView UWVA, eDP, 250 nits, 45% NTSC, time of flight sensor, with 5MP+ camera (1920 x 1200) 10,11,13

35.56 cm (14") diagonal WUXGA Bent touch screen, BrightView UWVA, eDP, 250 nits, 45% NTSC, time of flight sensor, with 5MP+ camera for WWAN (1920  $\times$  1200)  $^{10,11,13}$ 

35.56 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, anti-glare UWVA eDP1.4+PSR, 400 nits, 100% sRGB, Low Pow Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR Camera (1920 x 1200) with HP Eye Ease <sup>10,11,13</sup> 35.56 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, anti-glare UWVA eDP1.4+PSR, 400 nits, 100% sRGB, Low Pow Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR Camera for WWAN (1920 x 1200) with HP Eye Ea 10,11,13

35.56 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, BrightView UWVA eDP1.4+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR Camera (1920 x 1200) with HP Eye Ease 10,11,13

35.56 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, BrightView UWVA eDP1.4+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR Camera for WWAN (1920 x 1200) with HI Eve Ease 10,11,13

35.56 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, anti-glare UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera (1920 x 1200) with HP Eye Ease <sup>10,11,12,13</sup>

35.56 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, anti-glare UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera for WWAN (1920 x 1200) with HP Eye Ease 10,11,12,13

35.56 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, BrightView UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HI Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera (1920 x 1200) with HP Eye Ease <sup>10,11,12,13</sup>

35.56 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, BrightView UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HI Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera for WWAN (1920 x 1200) with HP Eye Ease 10,11,12,13

#### DisplayPort<sup>TM</sup> 1.2

### **Technical Specifications**

HDMI 2.0 Support resolution up to 4K @60 Hz 8

#### **Displays support**

Supports dual display through the dock

#### Display Size (diagonal)

14'

35.56 cm (14")

- 9. HDMI cable sold separately
- 10. HD content required to view HD images.
- 11. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 12. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.
- 13. Actual brightness will be lower with touchscreen or HP Sure View.

## **DOCKING (Sold Separately)**

Docking station model #1 HP Thunderbolt Dock G2
Docking station model #2 HP USB-C Dock G5

**Docking station model #3** HP USB-C/A Universal Dock G2

For additional aftermarket options and docking specs please see page 40.

## STORAGE AND DRIVES

#### **Primary M.2 Storage**

2 TB PCIe® Gen4x4 NVMe<sup>TM</sup> M.2 SSD TLC <sup>14</sup>
1 TB PCIe® Gen4x4 NVMe<sup>TM</sup> M.2 SSD TLC <sup>14</sup>
512 GB PCIe® Gen4x4 NVMe<sup>TM</sup> M.2 SSD TLC <sup>14</sup>
512 GB PCIe® Gen4x4 NVMe<sup>TM</sup> SED TLC OPAL2 <sup>14</sup>
512 GB PCIe® NVMe<sup>TM</sup> Value M.2 SSD <sup>14</sup>
256 GB PCIe® Gen4x4 NVMe<sup>TM</sup> M.2 SSD TLC <sup>14</sup>
256 GB PCIe® Gen4x4 NVMe<sup>TM</sup> SED TLC OPAL2 <sup>14</sup>
256 GB PCIe® NVMe<sup>TM</sup> Value M.2 SSD <sup>14</sup>

14. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 a 11) is reserved for system recovery software.

## **MEMORY**

### **Technical Specifications**

#### **Maximum Memory**

16 GB DDR5-4800 15

#### Memory

16 GB DDR5-4800 <sup>15</sup> 8 GB DDR5-4800 <sup>15</sup>

#### **Memory Slots**

Memory soldered down DDR5 SODIMMS, system runs at 4800 Supports Dual Channel Memory

15. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to enscompatibility. If you mix memory speeds, the system will perform at the lower memory speed.

## **NETWORKING/COMMUNICATIONS**

#### WLAN

Intel® AX211 Wi-Fi6E +BT5.2 M.2 160MHz CNVi World-Wide WLAN vPro <sup>16,17,18</sup> Intel® AX211 Wi-Fi6E +BT5.2 M.2 160MHz CNVi World-Wide WLAN non-vPro <sup>16,18</sup>

#### **WWAN**

Intel® 5000 5G Solution WWAN <sup>19,20</sup>
Intel® XMM 7560 R+ LTE-Advanced Pro WWAN (Cat 16) <sup>19</sup>

#### NFC

Near Field Communications Controller <sup>21</sup>
HP Module with NXP NFC Controller NPC300 I2C NCI

#### Miracast

Native Miracast Support 22

16. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

17. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

18. For full Intel® vPro<sup>TM</sup> functionality, Windows, a vPro supported processor, vPro enabled chipset, vPro enabled WLAN card and discrete TPM 2.0 are required. See https://www.intel.com/content/www/us/en/architecture-and-technology/vpro/vpro-platforgeneral.html

19. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Chewith service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, netwo conditions, and other factors. 4G LTE not available on all products, in all regions.

20. Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR an LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds w vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSP technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

21. Sold separately or as an optional feature.

22. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

#### **AUDIO/MULTIMEDIA**

### **Technical Specifications**

#### **Audio**

Audio by Bang & Olufsen 2 Integrated stereo speakers Discrete Amplifiers Integrated dual array microphone

#### **Speaker Power**

2W/4ohm Per speaker

#### Camera

5 MP camera <sup>21</sup> 5 MP+IR camera <sup>21</sup>

#### Sensors

ALS (ambient light sensor)
Magnetometer
Hall Sensor
Gyro
Accelerometer
HP Tamper Lock <sup>23</sup>

- 21. Sold separately or as an optional feature.
- 23. HP Tamper Lock must be enabled by the customer or your administrator.

## **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

### Keyboard

HP Premium Keyboard, spill resistant, Backlit keyboard and DuraKeys

#### **Pointing Device**

Clickpad with multi-touch gesture support, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

#### **Function Keys**

**ESC:** system information

F1 - Display Switching

F2 - Blank or Privacy

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Insert

F11 - Airplane Mode

F12 - HP Command Center

home

end

Power Button (with LED)

Delete

#### **Hidden Function Keys**

### **Technical Specifications**

Fn+R - Break Fn+S - Sys Rq

Fn+C - Scroll Lock

### **SOFTWARE AND SECURITY**

#### Software

**HP Quick Touch** 

HP Quick Drop 24

HP Easy Clean 25

**HP PC Hardware Diagnostics Windows** 

mvHP

Tile App 26

HP Smart Support 27

HP Connection Optimizer

**HP Hotkey Support** 

HP Support Assistant 28

**HP Notifications** 

**HP Privacy Settings** 

**HP Power Manager** 

Buy Microsoft Office (Sold separately)

#### **Manageability Features**

HP Image Assistant Gen5 (download)

HP Manageability Integration Kit (download) 29

HP Client Management Script Library (download)

**HP Driver Packs (download)** 

HP Cloud Recovery 30

HP Client Catalog (download)

## **Security Management**

#### HP Wolf Security of Business 31 includes:

HP Sure Click 32

HP Sure Sense 33

HP Sure Run Gen5 34

HP Sure Recover Gen5 35

HP Sure Start Gen7 36

**HP Tamper Lock** 

HP Sure Admin 37

HP Client Security Manager Gen7 38

#### BIOS

HP BIOSphere Gen6 39

HP Secure Erase 40

Absolute Persistence Module 41

**HP DriveLock & Automatic DriveLock** 

**BIOS Update via Network** 

HP Wake on WLAN

HP Fingerprint Sensor 42

Secured-Core PC Enable <sup>43</sup>

TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

#### Security TPM

Model: Infineon SLB9672VU2.0

Version: 15.21

### **Technical Specifications**

Revision: TPM 2.0

FIPS 140-2 Compliant: Yes

#### **Smartcard Reader**

Model number: Alcor AU9560 FIPS 201 Compliant: Yes

#### **IPv6 Support**

Yes

#### **FirstNet Certified**

Yes

#### Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes

UEFI version: 2.7 Class: Class 3

24. HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Andro device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

25. HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are n disabled. See user guide for cleaning instructions.

26. Some Tile features require optional subscription to Tile Premium. Tile application for Windows 10 available for download from the Windows Store. Mobile phone app available for download from App Store and Google Play. Requires iOS 11 and greater or Android 6.0 and greater see https://support.thetileapp.com/hc/en-us/articles/200424778 for more information. Tile will functio as long as the PC has battery power.

27. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

28. HP Support Assistance requires Windows and Internet Access.

29. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.htm 30. HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. Note: You must back up important files, data, photos, videos, etc. before use to avo loss of data. Detail please refer to: https://support.hp.com/us-en/document/c05115630.

31. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Prc Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

32. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A\_SureClick for complete details.

33. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.

34. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.

35. HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module.

36. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher.

37. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

38. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.

39. HP BIOSphere Gen6 features may vary depending on the platform and configuration.

40. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane<sup>TM</sup>.

41. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, ch with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.

42. HP Fingerprint sensor is an optional feature that must be configured at purchase.

43. Secured-Core PC Enable requires an Intel® vPro®, AMD Ryzen<sup>TM</sup> Pro processor or Qualcomm® processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.

### **Technical Specifications**

#### **POWER**

#### **Power Supply**

HP Smart 65 W USB Type-C adapter <sup>44</sup> HP Smart 65 W Slim USB Type-C adapter <sup>44</sup> HP Smart 45 W USB Type-C adapter <sup>44</sup>

#### **Battery**

HP Long Life 3-cell, 38 Wh Polymer <sup>45,46</sup> HP Long Life 3-cell, 51 Wh Polymer <sup>45,46</sup> Compliant with UL 1642 Standard

#### **Power Cord**

3-wire plug - 1m 2-wire plug - 1m

#### **Battery Life**

Up to 13 hours 45 minutes (51 Whr battery) <sup>47</sup> Up to 10 hours (38 Whr battery) <sup>47</sup>

44. Availability may vary by country.

45. Battery is internal and not replaceable by customer. Serviceable by warranty.

46. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.
47. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, feature use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

### **WEIGHTS & DIMENSIONS**

**Product Weight- 38 Wh <sup>48</sup>**Starting at 2.98 lb
Starting at 1.35 kg

Product Dimensions (W x D x H)

12.42 x 8.89 x 0.75 in 31.56 x 22.565 x 1.92 cm

48. Weight will vary by configuration. Does not include power adapter.

## PORTS/SLOTS



2 Thunderbolt<sup>TM</sup> 4 with USB4 Type-C<sup>®</sup> 40Gbps signaling rate (USB Power Delivery, DisplayPort<sup>TM</sup> 1.4) <sup>49</sup>

2 Super Speed USB Type-A 5Gbps signaling rate (1 charging) (USB 3.2 Gen 1)

1 HDMI 2.0 9

1 Headphone/microphone combo jack

1 Nano Security Lock Slot (Lock sold separately)

1 Smartcard reader (Optional)

1 nano SIM card slot

9. HDMI cable sold separately

49. SuperSpeed USB 20Gbps is not available with Thunderbolt<sup>TM</sup> 4.

## SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is als available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc

50. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicate Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

## SYSTEM UNIT

Stand-Alone Power Requirements Type-C Adapter

(AC Power)

Nominal Operating Voltage AC 20V

Average Operating Power

Integrated graphics Yes
Discrete Graphics N/A

Max Operating Power UMA<65W

**Temperature** 

Operating 32° to 95° F (0° to 35° C)

Non-operating 41° to 95° F (5° to 35° C) (writing optical)

**Relative Humidity** 

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

**Random Vibration** 

Operating 0.75 grams

### **Technical Specifications**

Non-operating 1.50 grams

**Altitude (unpressurized)** 

Operating -50 to 10,000 ft (-15.24 to 3,048 m) Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

**Planned Industry Standard** 

Certifications

Regulatory Model Number HSN-145C
UL Yes
CSA Yes
FCC Compliance Yes

ENERGY STAR® Certified 51

EPEAT® Gold in the United States 52

**ICES** Yes Australia / Yes **NZ A-Tick Compliance** Yes CCCYes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes GOST Yes Saudi Arabian Compliance (ICCP) Yes SABS Yes

51. Configurations of the HP Elite x360 1040 14 inch G9 2-in-1 Notebook PC that are ENERGY STAR® qualified are identified as HP Elite x360 1040 14 inch G9 2-in-1 Notebook PC ENERGY STAR on HP websites and on http://www.energystar.gov.

52. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information.

## **DISPLAYS**

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

## **Technical Specifications**

14.0 in WUXGA

(1920 x 1200) Anti-Glare **UWVA LED NTSC NB2X 250** eDP 1.2 w/o PSR 45 bent LCD **Panel** 

Outline Dimensions (W x H x D)

307.590 x 199.550 (max) 301.590 X 188.500 (typ) **Active Area** 

300 (max) Weight

14 Diagonal Size

3.0 / 5.0 (max) **Thickness** 

eDP 1.2 Interface Anti-Glare **Surface Treatment** Yes1 **Touch Enabled** 

**Contrast Ratio** 1000:1(typ) **Refresh Rate** 60 Hz 250 nits 1 **Brightness** 

**Pixel Resolution - Format** 1920 x 1200 (WUXGA)

**WLED** Backlight P.P.I. 162 **Pixel Resolution - configuration RGB NTSC 45% Color Gamut Coverage** 8 bits **Color Depth** 

UWVA 89/89/89/89 **Viewing Angle** 

**Low Blue Light** Nο

Power Consumption (W, EBL@ 150nits 2.20 (max) / 2.70 (max)

max/ 200nits max)

**Active Area** 

14.0 in WUXGA

(1920 x 1200) Anti-Glare **UWVA WLED+LBL sRGB NB2X** 400 eDP 1.4+PSR2 Low-Power 100 bent LCD Panel

Outline Dimensions (W x H x D)

307.590 x 199.550 (max) 301.590 X 188.500 (typ)

Weight 210 (max)

**Diagonal Size** 14

2.0 / 3.8 (max) **Thickness** 

Interface eDP 1.4 **Surface Treatment** Anti-Glare Yes 1 **Touch Enabled Contrast Ratio** 1000:1(typ)

**Refresh Rate** 60 Hz 400 nits 1 **Brightness** 

1920 x 1200 (WUXGA) **Pixel Resolution - Format** 

**Backlight WLED** P.P.I. 162 **RGB Pixel Resolution - configuration** 

sRGB 100% **Color Gamut Coverage Color Depth** 8 bits

**Viewing Angle** UWVA 89/89/89/89

Yes Low Blue Light

150nits max/ 200nits max)

1.29 (max) / 1.66 (max) Power Consumption (W, EBL@

### **Technical Specifications**

14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD

Panel

 Outline Dimensions (W x H x D)
 307.600 x 199.550 (typ)

 Active Area
 301.680 x 188.500 (typ)

Weight 238 (max)

Diagonal Size 14

**Thickness** 2.2 / 3.9 (max)

Interface eDP 1.3

Surface Treatment Anti-Glare
Touch Enabled Yes<sup>1</sup>

Contrast Ratio1500:1(typ)Refresh Rate60 HzBrightness1000 nits1

Pixel Resolution - Format 1920 x 1200 (WUXGA)

BacklightWLEDP.P.I162Pixel Resolution - configurationRGBColor Garmut CoveragesRGB 100%Color Depth8 bits

Viewing Angle UWVA 85/85/85

Low Blue Light Yes
Power Consumption (W, EBL@ N/A

150nits max/ 200nits max)

#### STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

SSD 256GB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 256GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 4000 MB/s ±20%

 Maximum Sequential Write
 2000 MB/s ±20%

 Logical Blocks
 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** Pyrite 2.0; TRIM; L1.2

### **Technical Specifications**

SSD 512GB 2280 PCie-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 512GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 3500 MB/s ±20%

 Logical Blocks
 1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** Pyrite 2.0; TRIM; L1.2

SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 1TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 5000 MB/s ±20%

 Logical Blocks
 2,000,409,264

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** Pyrite 2.0; TRIM; L1.2

SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 2TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 5000 MB/s ±20%

 Logical Blocks
 4,000,797,360

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** Pyrite 2.0; TRIM; L1.2

### **Technical Specifications**

256GB PCIe-4x4 2280 NVME Form Factor
Self Encrypted OPAL2 Three
Capacity
Layer Cell Solid State Drive

Form Factor M.2 2280
Capacity 256GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 4000 MB/s ±20%

 Maximum Sequential Write
 2000 MB/s ±20%

 Logical Blocks
 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features TCG Opal 2.0; TRIM; L1.2

512GB PCIe-4x4 2280 NVME Form Factor
Self Encrypted OPAL2 Three
Layer Cell Solid State Drive
LAND Topology

Form Factor M.2 2280
Capacity 512GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 3500 MB/s ±20%

 Logical Blocks
 1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features TCG Opal 2.0; TRIM; L1.2

SSD 256GB 2280 PCIe NVMe Value Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

 Maximum Sequential Read
 1500 MB/s ±20%

 Maximum Sequential Write
 750 MB/s ±20%

 Logical Blocks
 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

### **Technical Specifications**

SSD 512GB 2280 PCIe NVMe

Value

Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

 Maximum Sequential Read
 1500 MB/s ±20%

 Maximum Sequential Write
 750 MB/s ±20%

 Logical Blocks
 1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** Pyrite 2.0; TRIM; L1.2

### **NETWORKING/COMMUNICATIONS**

Intel® AX211 Wi-Fi 6E + Bluetooth® 5.2 M.2 160MHz CNVi World-Wide WLAN vPro<sup>1,5</sup>

Wireless LAN Standards

IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11d
IEEE 802.11d
IEEE 802.11h
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k

Interoperability

IEEE 802.11v Wi-Fi certified

IEEE 802.11r

**Frequency Band** 

802.11b/g/n/ax2.402 - 2.482 GHz802.11a/n/ac/ax

4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz 5.955 - 6.415 GHz 6.435 - 6.515 GHz 6.535 - 6.875 GHz 6.895 - 7.115 GHz

**Data Rates** 

• 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps802.11ac : 1733Mbps802.11ax : max 2.4Gbps

**Modulation** Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

### **Technical Specifications**

Security<sup>2</sup> IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x, WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification WPA3 certification IEEE 802.11i WAPI

**Network Architecture** 

Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power<sup>3</sup> 802.11b: +17dBm minimum

802.11q: +16dBm minimum 802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +14dBm minimum 802.11n HT40(5GHz): +13dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum 802.11ac VHT160(5GHz): +10dBm minimum 802.11ax HE40(2.4GHz): +12dBm minimum 802.11ax HE80(5GHz): +10dBm minimum 802.11ax HE160(5GHz): +10dBm minimum

**Power Consumption** Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW

Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity<sup>4</sup> 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/q, 6Mbps: -86dBm maximum 802.11a/q, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum

802.11ac, MCS0(VHT80): -84dBm maximum 802.11ac, MCS9(VHT80): -59dBm maximum 802.11ac, MCS9(VHT160): -58.5dBm maximum 802.11ax, MCS11(HE40): -57dBm maximum 802.11ax, MCS11(HE80): -54dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

**Form Factor** PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

Weight 1. Type 2230: 2.8g

**Operating Voltage** 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (-10° to 70° C)

> -40° to 176° F (-40° to 80° C) Non-operating

**Humidity** Operating 10% to 90% (non-condensing)

5% to 95% (non-condensing) Non-operating

### **Technical Specifications**

**Altitude Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF; LED OFF - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1/5.2 Compliant

Frequency Band 2402 to 2480 MHz

Number of AvailableLegacy: 0~79 (1 MHz/CH)ChannelsBLE: 0~39 (2 MHz/CH)

**Data Rates and**Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 9.5 dBm for BR and EDR.

**Power Consumption** Peak (Tx): 330 mW

Peak (Rx): 230 mW

Selective Suspend: 17 mW

**Bluetooth Software** 

Supported Link Topology Microsoft Windows Bluetooth Software

**Power Management** Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C. Section 15.247 & 15.249

Power Management Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

**Bluetooth Profiles** 

Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 -Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

BT5.2

ESR9/10 Compliance

LE Advertisement Extensions Channel Selection Algo

Limited High Duty Cycle Non-Connectable Advertising

2Mbps LE LE Long Range

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limite Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

## **Technical Specifications**

- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
- 5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requi a wireless router, sold separately, that supports 80MHz and higher channels.

Intel® AX211 Wi-Fi 6E +
Bluetooth® 5.2 M.2
160MHz CNVi World-Wide
WLAN non-vPro <sup>®1,5</sup>

#### **Wireless LAN Standards**

IEEE 802.11a IEEE 802.11b IEEE 802.11q IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r

IEEE 802.11v

#### Interoperability

#### **Frequency Band**

Wi-Fi certified

 802.11b/g/n/ax 2.402 - 2.482 GHz

802.11a/n/ac/ax

4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz 5.955 - 6.415 GHz 6.435 - 6.515 GHz 6.535 - 6.875 GHz 6.895 - 7.115 GHz

#### **Data Rates**

• 802.11b: 1, 2, 5.5, 11 Mbps

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11n: max 300Mbps • 802.11ac: 1733Mbps 802.11ax : max 2.4Gbps

#### Modulation

Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>2</sup> IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification WPA3 certification IEEE 802.11i WAPI

#### **Network Architecture**

Ad-hoc (Peer to Peer)

Models

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power<sup>3</sup> 802.11b: +17dBm minimum

### **Technical Specifications**

802.11g : +16dBm minimum 802.11a : +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +14dBm minimum 802.11n HT40(5GHz): +13dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum 802.11ac VHT160(5GHz): +10dBm minimum 802.11ax HE40(2.4GHz): +12dBm minimum 802.11ax HE80(5GHz): +10dBm minimum 802.11ax HE160(5GHz): +10dBm minimum

**Power Consumption** Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW

Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity**<sup>4</sup> 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum

802.11ac, MCS0(VHT80): -84dBm maximum 802.11ac, MCS9(VHT80): -59dBm maximum 802.11ac, MCS9(VHT160): -58.5dBm maximum 802.11ax, MCS11(HE40): -57dBm maximum 802.11ax, MCS11(HE80): -54dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum

**Antenna type** High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230 : 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230 : 2.8g 2. Type 1216: 1.3g

Operating Voltage 3.3v +/- 9%

**Temperature Operating** 14° to 158° F (-10° to 70° C)

**Non-operating** -40° to 176° F (-40° to 80° C)

**Humidity Operating** 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber - Radio OFF; LED OFF - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1/5.2 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)
Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 9.5 dBm for BR and EDR.

**Power Consumption** Peak (Tx): 330 mW

Peak (Rx): 230 mW

Selective Suspend: 17 mW

Bluetooth Software

Microsoft Windows Bluetooth Software

Supported Link Topology Power Management

Microsoft Windows ACPI, and USB Bus Support FCC (47 CFR) Part 15C. Section 15.247 & 15.249

Power Management

**Certifications** 

Supported

ETS 300 328. ETS 300 826

Low Voltage Directive IEC950

Certifications

**Bluetooth Software** 

UL, CSA, and CE Mark

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 -Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

BT5.2

ESR9/10 Compliance

LE Advertisement Extensions Channel Selection Algo

Limited High Duty Cycle Non-Connectable Advertising

2Mbps LE LE Long Range

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limite Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

2. Check latest software/driver release for updates on supported security features.

3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requi a wireless router, sold separately, that supports 80MHz and higher channels.

Intel(R) 5G Solution

**Technology/Operating bands** WCDMA/HSPA+ operating bands:

# Technical Specifications 50001

```
Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
LTE FDD/TDD operating bands:
Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)
Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)
Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL)
Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL)
Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL)
Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL)
Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL)
Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL)
Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)
Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)
Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL)
Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)
Band 29: 717 to 728 MHz (DL)
Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)
Band 32: 1452 to 1496 MHz (DL)
Band 34: 2010 to 2025 MHz (UL/DL)
Band 38: 2570 to 2620 MHz (UL/DL)
Band 39: 1880 to 1920 MHz (UL/DL)
Band 40: 2300 to 2400 MHz (UL/DL)
Band 41: 2496 to 2690 MHz (UL/DL)
Band 42: 3400 to 3600 MHZ (UL/DL)
Band 43: 3400 to 3800 MHZ (UL/DL)
Band 46: 5150 to 5925 MHZ (DL)
Band 48: 3550 to 3700 MHZ (UL/DL)
Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL)
Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)
5GNR Sub 6GHZ
n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)
n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)
n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)
n25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)
n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)
n38: 2570 to 2620 MHz (UL/DL)
n40: 2300 to 2400 MHz (UL/DL)
n41: 2496 to 2690 MHz (UL/DL)
n48: 3550 to 3700 MHZ (UL/DL)
n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL)
n71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)
n77: 3300 to 4200 MHz (UL/DL)
n78: 3300 to 3800 MHz (UL/DL)
n79: 4400 to 5000 MHz (UL/DL)
5GNR Air Interface
3GPP Rel15 5G NR sub-6
```

Wireless protocol standards

LTE Rel14

DA - 16997 Worldwide QuickSpecs — Version 1 — 5.20.2022

### **Technical Specifications**

20 layers and 2 Gbps downlink (DL) throughput - 4? 4 MIMO across 5x

200 Mbps/uplink (UL) throughput - 40 MHz ULCA and 256 OAM

WCDMA R99.

3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone, A-GPS (MS-A, MS-B)

**GPS** bands GPS: L1 (1575.42MHz)

GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42)

QZSS(1575.42 MHz)

SA 5G/NR sub-6 Peak: DL4.67Gbps/ UL 1.25Gbps Maximum data rates

> 5G NSA sub 6G: DL: 3.8 Gbps/UL 700Mbps LTE: ue-CategoryDL 19. (DL: 1.6 Gbps) ue-CategoryUL 13, (UL: 150Mbps)

DC-HSPA+: 42 Mbps (Download), 11.5 Mbps (Upload)

LTE: 23 dBm in all band except B41 Maximum output power

LTE B41 HPUE = 26dBm

NR: 23 dBm in all band except n41, n77, n78 and n79

LTE n41, n77, n78 and n79 HPUE = 26dBm

HSPA+: 23.5 dBm

**Maximum power consumption** 5G Sub 6: 2500 mA

> LTE: 1,300 mA (peak); 1100 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

**Form Factor** M.2, 3042-S3 Key B

Weight 8 a

**Dimensions** 52 mm? 30 mm? 2.6 mm

(Length x Width x Thickness)

1. Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors, Backwards compatible to 4G LTE and 3G HSPA technologies. module planned to be available in select platforms and select countries, where carrier supported.

Intel® XMM<sup>TM</sup> 7560 R+ LTE-Advanced Pro<sup>1</sup>

Technology/Operating FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band bands

12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30).

1700/2100 (Band 66), 600 (band 71).

TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200

(Band 46 RX only) MHz;

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

Wireless protocol

standards

3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput

up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)

**GPS** bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098

MHz

### **Technical Specifications**

Maximum data rates LTE: 978 Mbps (Download), 150 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21 Mbps (Download), 5.76 Mbps (Upload)

Maximum output power LTE: 23 dBm in all band except B41

LTE B41 HPUE = 26dBm

HSPA+: 23.5 dBm

Maximum powerLTE: 1,200 mA (peak); 900 mA (average)consumptionHSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6 g

**Dimensions** 42 x 30 x 2.3 mm

(Length x Width x Thickness)

eSIM Support

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Near Field Communications Controller (optional) Dimensions (L x W x H)

Module 25 mm by 10 mm by 2.0 mm

Chipset NPC100
System interface I2C

NFC RF standards ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

Reader (PCD-VCD)

Mode (1)

Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2 ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K

MIFARE DESFire

FeliCa

Jewel and Topaz cards

Card Emulation (PICC-VICC) Mode (1) ISO/IEC 14443 A ISO/IEC 14443 B and B'

MIFARE FeliCa

Frequency 13.56 MHz

**NFC Modes Supported** Reader/Writer, Peer-to-Peer **Raw RF Data Rates** 106, 212, 424, 848 kbps

Operating temperature0°C to 70°CStorage temperature-20°C to 125°CHumidity10-90% operating

5-95% non-operating

**Supply Operating voltage** 4.35 to 5.25 Volts **I/O Voltage** 1.8V or 3.3V

### **Technical Specifications**

**Power Consumption** 

(Booster enable, VBAT= 3.3V, VCC\_BOOST = 5V)

Mode Power Consumption, Typical

Polling 7.3 mA

Detected Test Tag Type 1 Total 283.8 mA

Net Module 236.8 mA

Detected Test Tag Type 2 Total 288.8 mA

Net Module 241.8 mA

Detected Test Tag Type 3 Total 287.7 mA

Net Module 240.7 mA

Detected Test Tag Type 4 Total 282.3 mA

Net Module 235.3 mA

Antenna Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is

external to module.

### **POWER**

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

AC Adapter 45 Watt nPFC Standard USB type C Straight 1.8m Dimensions (H x W x D)

94.0mm x 40.0mm x 26.5mm

Weight

192.5g +/-10%
Input Efficiency

Input

Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V: 81.5% 9V: 86.7% 12V: 87.41% 15V: 87.8%

Input frequency range 47 ~ 63Hz

Input AC current Max. 1.4 A at 90 Vac

Output Output power

5V/15W 9V/27W 12V/36W

15V/45W 5V/9V/12V/15V 5ms at 115 Vac input

Output current limit <5.0A

**Connector** C6

Environmental Design Operating

32°Fto 95°F (0° to 35°C)

temperature

DC output

Hold-up time

Non-operating (storage)

-4°F to 185°F (-20° to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety

Eg:

**Certifications** \*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1

and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class

B, CISPR32 Class B, CCC, NOM-001 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

**AC Adapter 65 Watt nPFC** Slim USB type C Straight 1.8m

Dimensions (H x W x D) Weight

Input

88 x 53.5 x 21mm unit: 220g +/- 10g

**Input Efficiency** 

81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

Input frequency range

47 ~ 63 Hz

**Input AC current** 

1.6 A at 90 VAC and maximum load

Output **Output power** 65W

> **DC** output 5V/9V/12V/15V/20V Hold-up time 5ms at 115 Vac input

**Output current limit** <8.0A

Connector **C6** 

**Environmental Design** 

**Operating** 32°Fto 95°F (0° to 35°C)

temperature

Non-operating (storage)

-4°F to 185°F (-20° to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

**Humidity** 5% to 95% **Storage Humidity** 5% to 95%

**EMI and Safety** Certifications

Eg:

\*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1

and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class

B, CISPR32 Class B, CCC, NOM-001 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Standard USB type C Straight 1.8m

Dimensions (H x W x D)

Weight Input

Output

90.0mm x 51.0mm x 28.5mm

250g +/-10%

**Input Efficiency** Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V:81.5% 9V:86.7% 12V:88% 15V:88% 20V:89%

Input frequency range

47 ~ 63Hz

**Input AC current** 

Max. 1.6 A at 90 Vac

**Output power** 

5V/15W

9V/27W 12V/60W 15V/60W 20V/65W

**DC** output 5V/9V/12V/15V/20V Hold-up time 5ms at 115 Vac input

**Output current limit** 

<8.0A

Connector

**Environmental Design** 

Operating

**C6** 

32°Fto 95°F (0° to 35°C)

temperature

Non-operating (storage)

-4°F to 185°F (-20° to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety** Certifications

Eg:

\*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1

and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class

B, CISPR32 Class B, CCC, NOM-001 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

**HP 3-cell Long Life Li-Ion** 

(38Wh) 1

Dimensions (H x W x D) 251.8 x 66.1 x 6.82mm (9.91 x 2.6 x 0.27 inch)

Weight 0.184kg +/- 10g(0.406lb)

Cells/Type 3cell Lithium-Ion Polymer cell / 564975

Energy Voltage 11.58V

> **Amp-hour capacity** 3.283Ah Watt-hour capacity<sup>1</sup> 38Wh

Operating (Charging) 32? to 113? F (0? to 45? C)

> Operating (Discharging) 14? to 140? F (-10? to 60? C)

Fuel Gauge LED

Warranty Follow product spec

**Optional Travel Battery** No

**Available** 

**HP 3-cell Long Life Li-Ion** 

(51 Wh) 1

Dimensions (H x W x D)

**Temperature** 

251.8 x 70.3 x 6.82mm (9.91 x 2.77 x 0.27 inch)

0.229kg +/- 10g (0.505 lb) Weight

Cells/Type 3cell Lithium-Ion Polymer cell / 566075

Energy Voltage 11.58V

> 4.431Ah **Amp-hour capacity** Watt-hour capacity<sup>1</sup> 51.3Wh

**Temperature** Operating (Charging) 32? to 113? F (0? to 45? C)

> Operating (Discharging) 14? to 140? F (-10? to 60? C)

Fuel Gauge LED

Follow product spec Warranty

**Optional Travel Battery** No

**Available** 

**AUDIO** 

**HD Stereo Codec** Realtek ALC3315

**Audio I/O Ports** Headset: CTIA only and Headphone-out

**Internal Speaker Amplifier** Cirrus Logic High-Efficiency Boosted Class D Amplifier

**Multi-streaming Capable** Playback multi-streaming can be enabled in the audio control panel to allow

independent audio. Following MSFT Behaviour

Sampling DAC: 44.1k/48kHz

ADC: 48kHz

**Wavetable Syntheses Analog Audio** 

# of Channels on Line-Out

Support 3.5mm Headset: CTIA only and Headphone-out

**Internal Speaker** 

Yes

### FINGERPRINT READER

### **Technical Specifications**

**Sensor vendor** Synaptics FS7604 Capacitive Sensor type

363DPI **DPI** resolution

7.4x6mm sensor area Scan area

<1% **False Rejection Rate** 

1:50K FAR **False Acceptance Rate Mobile Voltage Operation** 3.0V to 3.6V 0~60°C **Operating Temperature** 100mA Max **Current Consumption Image** 

260 uA **Low Latency Wait For Finger Capture Rate** <30msec per image

IEC 61000-4-2 4B (+/-15KV) **ESD Resistance** 363 dpi / 7.4x6mm sensor area **Detection Matrix** 

Eco-Label Certifications &	This product has received or is in the process of being certified to the following approvals and may be						
declarations	labeled with one or more of these marks:						
400.41	<ul> <li>IT ECO declaration</li> </ul>						
	US ENERGY ST	TAR®					
	<ul> <li>US Federal Energy</li> </ul>	Management Program (FEMP)					
			ttp://www.epeat.net for registration statu				
	your country.						
	TCO Certified						
	China Energy Cons	ervation Program (CECP)					
		nmental Protection Administra	tion (SEPA)				
	Taiwan Green Mark						
	Korea Eco-label						
	Japan PC Green label*						
Sustainable Impact	<ul> <li>Ocean-bound p</li> </ul>	lastic in Speaker					
Specifications	45% post-consumer recycled plastic						
	Low halogen						
	Outside Box and corrugated cushions are 100% sustainably sourced and						
	recyclable						
	Molded Paper Pulp Cushion inside box is 100% sustainably sourced and						
	recyclable						
	Bulk packaging available						
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the						
system comiguration	ebook"?.						
Energy Consumption							
(in accordance with US							
ENERGY STAR® test							
method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz				
Normal Operation (Sort			•				
idle)	4.83 W	5.13 W	4.97 W				
Normal Operation (Long							
idle)	1.11 W 1.2 W 1.33 W						
Sleep	1.11 W 1.2 W 1.33 W						
Off	0.43 W	0.47 W	0.43 W				
UII							

## **Technical Specifications**

	family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.					
Heat Dissipation*	115VAC,	60Hz	230VAC, 50Hz		100VAC, 50Hz	
Normal Operation (Short						
idle)	16.5 BT	U/hr	17.5 BTU/hr		17 BTU/hr	
Normal Operation (Long idle)	3.8 BT	U/br	4.1 BTU/hr		4.5 BTU/hr	
Sleep	3.8 BT		4.1 BTU/hr		4.5 BTU/hr	
Off	1.5 BT		1.6 BTU/hr		1.5 BTU/hr	
	attained for o	one hour.			ssuming the service level is	
Declared Noise Emissions		Sound Powe	r	Sound Pressure		
(in accordance with ISO 7779 and ISO 9296)		(L <sub>WAd</sub> , bels)		(L <sub>pAm</sub> , (	decibels)	
Typically Configured - Idle		2.6			4.3	
Fixed Disk - Random writes		3.2			7.0	
Optical Drive - Sequential	4.0 32.0					
reads Longevity and Upgrading	This product can be upgraded, possibly extending its useful life by several years.					
Additional Information	<ul> <li>Spare parts are available throughout the warranty period and or for up to "5"? years after end of production.</li> <li>This product is in compliance with the Restrictions of Hazardous Substances (Rodirective - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; S Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold I see www.epeat.net</li> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11 and ISO1043.</li> <li>This product is 93.4% recycle-able when properly disposed of at end of life.</li> </ul>			dous Substances (RoHS) etrical and Electronic (State of California; Safe standard at the Gold level, re marked per ISO11469		
Packaging Materials	External:	PAPER/C	Corrugated		269 g	
		PAPER/P	Paper		3 g	
			Molded Pulp		108 g	
	•			ansity - I DDF	13 g	
	Internal: PLASTIC/Polyethylene low density - LDPE 13 g  The plastic packaging material contains at least 0.0% recycled content.					
	The corrugated paper packaging materials contains at least 59.1% recycled content.					
HP Inc. complies fully with materials regulations. We were among the first companie extend the restrictions in the European Union (EU) Restriction of Hazardous Substa (RoHS) Directive to our products worldwide through the HP GSE. HP has contribute development of related legislation in Europe, as well as China, India, and Vietnam.			the first companies to Hazardous Substances HP has contributed to the ia, and Vietnam.			
	We believe the RoHS directive and similar laws play an important role in promoting industry- wide elimination of substances of concern. We have supported the inclusion of additional					

### **Technical Specifications**

substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

#### **Material Usage**

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen\_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

#### **Packaging Usage**

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

## End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information

	for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a> . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate Environmental Information	For more information about HP's commitment to the environment:  Global Citizenship Report
	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications  http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
	ISO 14001 certificates:     http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842     and     http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/cert.pdf
footnotes	<ul> <li>Percentage of ocean-bound plastic contained in each component varies by product</li> <li>Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.</li> <li>External power supplies, WWAN modules, power cords, cables and peripherals excluded.</li> <li>100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.</li> </ul>
	Fiber cushions made from 100% recycled wood fiber and organic materials.

### **COUNTRY OF ORIGIN**

China

Options and Accessories (Sold separately and availability may vary by country)

4

**DOCKING (Sold Separately)** 

Docking station model #1

Total number of supported displays

(incl.the notebook display)

Max.resolutions supported

**Dock Connectors** 

utod

Dual 4K @30Hz or dual 4K UHD @ 60Hz is supported

Single 8K@ 30Hz (multiple tiles) for Thunderbolt hosts

Non-TBT hosts DP 1.4 in high res mode (1) 8K video single cable@30Hz [10]

2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode

**Technical limitations**Thunderbolt Hosts:

Maximum of (4) displays with maximum resolution of 5K@ 30Hz running

Thunderbolt host.

Max resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or

running a non-Thunderbolt host in High Resolution mode @30Hz

Non-Thunderbolt hosts:

**HP Thunderbolt Dock G2** 

The highest resolution for dual displays running a non-Thunderbolt host in multi-

function mode is

(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port

Non-Thunderbolt hosts support (3) displays with a max resolution of: (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1)

4K UHD @ 30Hz.

**Docking station model #2** 

Total number of supported displays

(incl.the notebook display)
Max.resolutions supported

**Dock Connectors** 

HP USB-C Dock G5

Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode) [10]

1xHDMI, 2xDP

**Technical limitations** Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution

mode.

3

Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K

UHD@ 30 Hz on HDMI in multi-function mode

The highest resolution for a non-Thunderbolt host in Multi-function mode is a

single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.

**Docking station model #3** 

Total number of supported displays (incl.the notebook display)

Max.resolutions supported

Dock Connectors

HP USB-C/A Universal Dock G2

3

Triple 4K UHD@ 60Hz [10]

1xHDMI, 2xDP

**Technical limitations**The best resolution for dual or triple displays is 4K UHD@ 60Hz.

For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the

host

Туре	Description	Part Number
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA
	HP Wired 3.5mm Stereo Headset	428K7AA
Cases	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Executive Slim 14.1 Top Load	6KD04AA
	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA

## Options and Accessories (Sold separately and availability may vary by country)

Mouse	HP USB Premium Wireless Mouse	1JR31AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP 320K WD USB Keyboard	9SR37AA
	HP 125 WD USB Keyboard	266C9AA
neyboar a/ combo	HP 455 Programmable Wireless Keyboard	4R177AA
Keyboard/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP USB 3.0 to Gigabit RJ45 Adapter G2	4Z7Z7AA
	HP USB-C to RJ45 Adapter G2	4Z527AA
	HP USB-C to VGA Adapter	N9K76AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to RJ45 Adapter	V7W66AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB to Gigabit RJ45 Adapter	N7P47AA
	HP HDMI to VGA Adapter	H4F02AA
Adapter	HP HDMI to DVI Adapter	F5A28AA
	HP USB-C to USB-A Hub	Z6A00AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP Universal USB-C Multiport Hub	50H55AA
Hub	HP USB-C Mini Dock	1PM64AA
Digital Pen	HP Active RECHBL G3 Moonracer 2.0 Pen	6SG43AA
	HP USB-C/A 120W G2 Universal Dock	5TW13AA
	HP USB-C 120W G5 Dock	5TW10AA
	HP Thunderbolt 230W G2 Dock w/Combo Cable	3TR87AA
-	HP Thunderbolt 120W G2 Dock w/Audio	3YE87AA
Docking	HP Thunderbolt 120W G2 Dock	2UK37AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew 14 Laptop Sleeve	2E6U9AA,2E6V0AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA

## Options and Accessories (Sold separately and availability may vary by country)

	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP Nano Keyed Cable Lock	1AJ39AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
	HP 65W USB-C Travel Slim Kermit AC Power Adapter	3PN48AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
	HP 65W USB-C Hades AC Power Adapter	1HE08AA
	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP 45W USB-C G2 Zeus AC Power Adapter	1HE07AA
Power	HP 65W USB-C Auto Chevy AC Power Adapter	5TQ76AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1D0K8AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 125 USB-A Wired Mouse	265A9AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA

## **Change Log**

Date of change:	Version History:	Description of change:
	V1 to V2	

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